

ShinEtsu

シリコーン熱伝導接着剤

Thermal conductive silicone adhesive

高熱伝導性／超低反り接着剤

Thermal conductive adhesive with ultra low warpage

室温硬化／速硬化、オープン不要

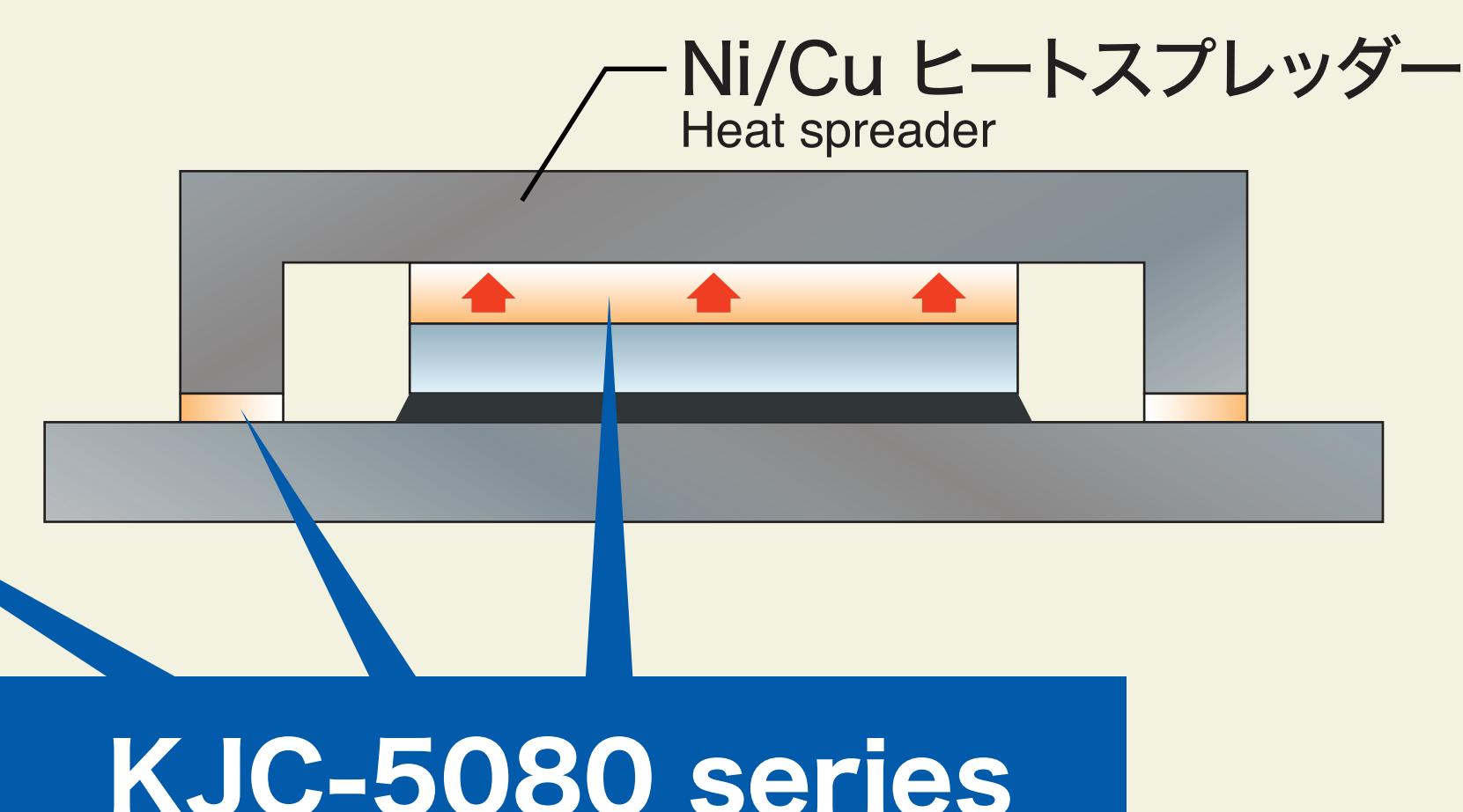
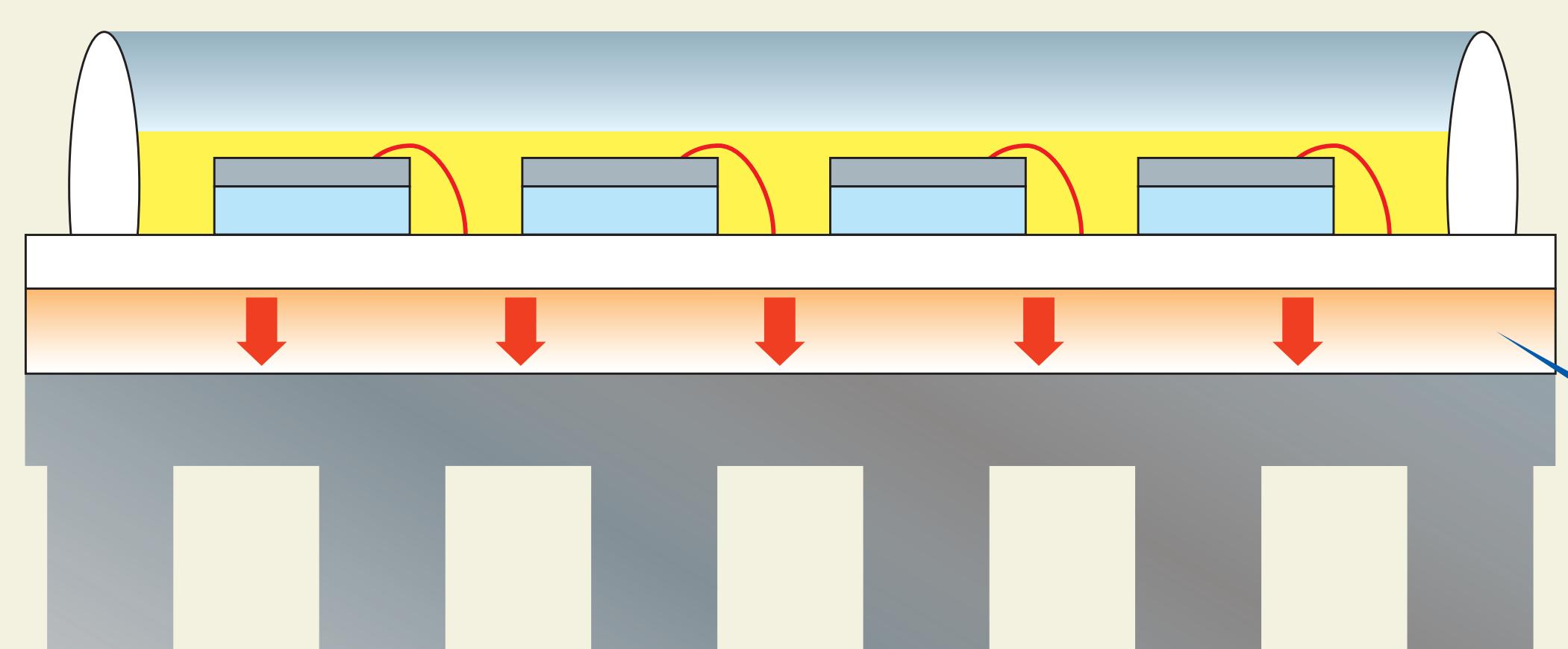
R.T. / snap curable, No-Oven

用途

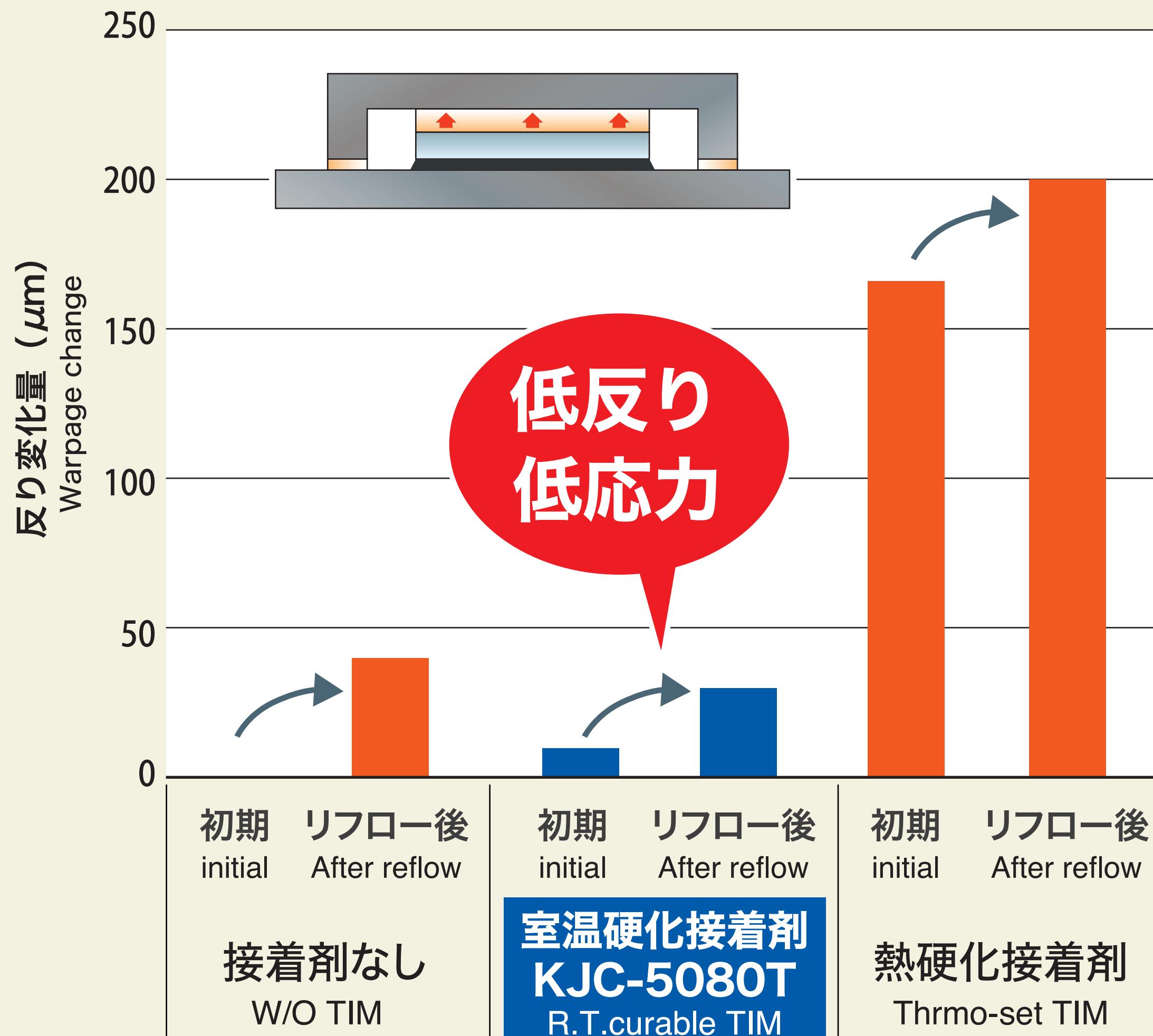
Application

高輝度LED、パワー半導体

High power LED, Power semi-conductor

**KJC-5080 series**

反り比較 Warpage comparison

KJC-5080T, New: 25°C 1hr
Benchmark: 100°C 2hr

熱伝導性 Thermal conductive

